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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	F²MC-16LX
Core Size	16-Bit
Speed	16MHz
Connectivity	CANbus, EBI/EMI, SCI, Serial I/O, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	78
Program Memory Size	128KB (128K x 8)
Program Memory Type	Mask ROM
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 8x8/10b
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-BQFP
Supplier Device Package	100-QFP (14x20)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb90598gpf-gs-169

1. Product Lineup

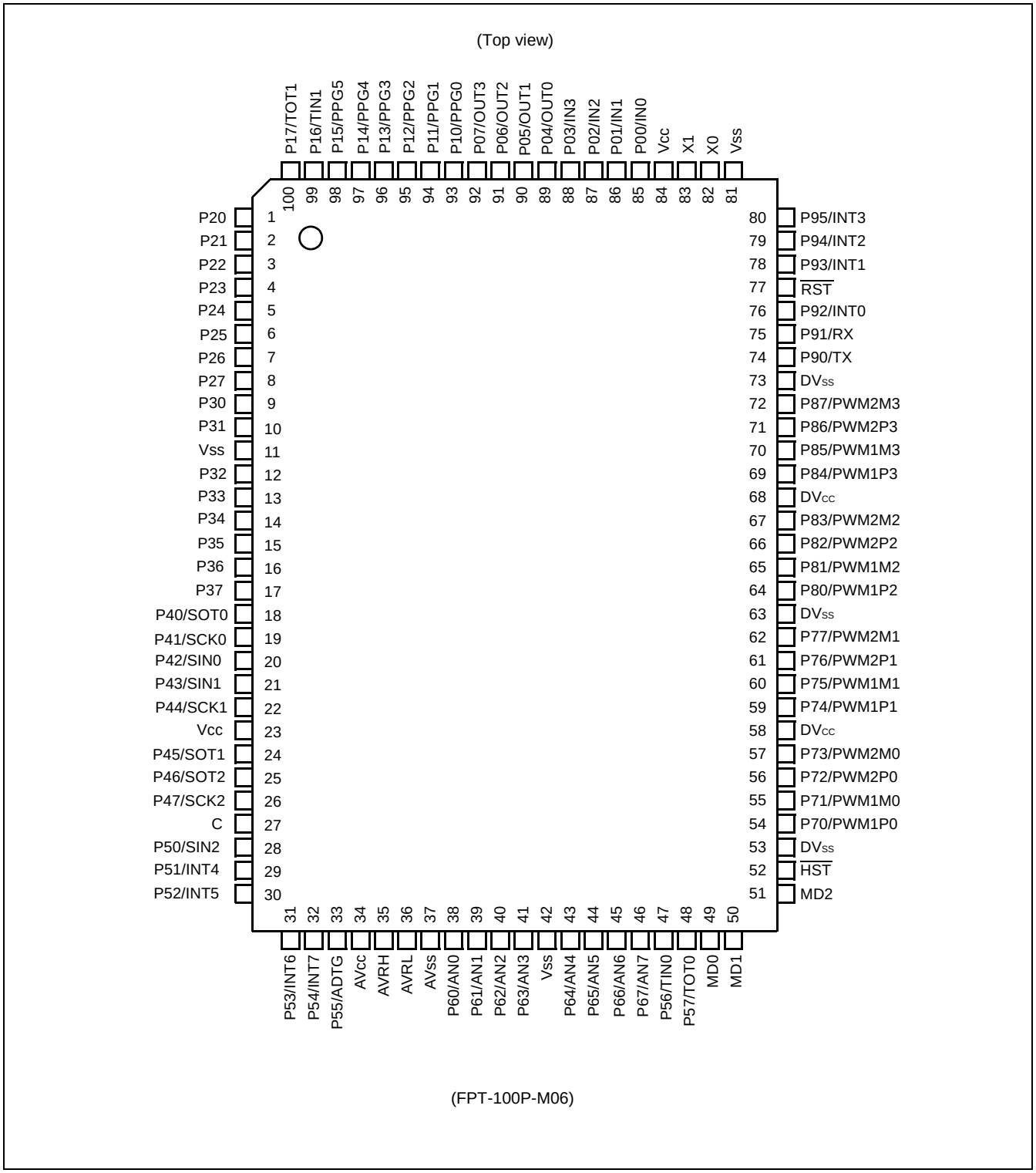
Features		MB90598G	MB90F598G	MB90V595G
Classification		Mask ROM product	Flash ROM product	Evaluation product
ROM size		128 Kbytes	128 Kbytes Boot block Hard-wired reset vector	None
RAM size		4 Kbytes	4 Kbytes	6 Kbytes
Emulator-specific power supply *1		—		None
CPU functions		The number of instructions: 351 Instruction bit length: 8 bits, 16 bits Instruction length: 1 byte to 7 bytes Data bit length: 1 bit, 8 bits, 16 bits Minimum execution time: 62.5 ns (at machine clock frequency of 16 MHz) Interrupt processing time: 1.5 μs (at machine clock frequency of 16 MHz, minimum value)		
UART0		Clock synchronized transmission (500 K/1 M/2 Mbps) Clock asynchronized transmission (4808/5208/9615/10417/19230/38460/62500 /500000 bps at machine clock frequency of 16 MHz) Transmission can be performed by bi-directional serial transmission or by master/slave connection.		
UART1(SCI)		Clock synchronized transmission (62.5 K/125 K/250 K/500 K/1 Mbps) Clock asynchronized transmission (1202/2404/4808/9615/31250 bps) Transmission can be performed by bi-directional serial transmission or by master/slave connection.		
8/10-bit A/D converter		Conversion precision: 8/10-bit can be selectively used. Number of inputs: 8 One-shot conversion mode (converts selected channel once only) Scan conversion mode (converts two or more successive channels and can program up to 8 channels) Continuous conversion mode (converts selected channel continuously) Stop conversion mode (converts selected channel and stop operation repeatedly)		
8/16-bit PPG timers (6 channels)		Number of channels: 6 (8/16-bit × 6 channels) PPG operation of 8-bit or 16-bit A pulse wave of given intervals and given duty ratios can be output. Pulse interval: fsys, fsys/2^1, fsys/2^2, fsys/2^3, fsys/2^4 (fsys = system clock frequency) 128μs (fosc = 4MHz: oscillation clock frequency)		
16-bit Reload timer		Number of channels: 2 Operation clock frequency: fsys/2^1, fsys/2^3, fsys/2^5 (fsys = System clock frequency) Supports External Event Count function		
16-bit I/O timer	16-bit Output compares	Number of channels: 4 Pin input factor: A match signal of compare register		
	Input captures	Number of channels: 4 Rewriting a register value upon a pin input (rising, falling, or both edges)		

Features	MB90598G	MB90F598G	MB90V595G
CAN Interface	Number of channels: 1 Conforms to CAN Specification Version 2.0 Part A and B Automatic re-transmission in case of error Automatic transmission responding to Remote Frame Prioritized 16 message buffers for data and ID's Supports multiple messages Flexible configuration of acceptance filtering: Full bit compare / Full bit mask / Two partial bit masks Supports up to 1Mbps CAN bit timing setting: MB90598G/F598G:TSEG2 ≥ RSJW		
Stepping motor controller (4 channels)	Four high current outputs for each channel Synchronized two 8-bit PWM's for each channel		
External interrupt circuit	Number of inputs: 8 Started by a rising edge, a falling edge, an "H" level input, or an "L" level input.		
Serial IO	Clock synchronized transmission (31.25 K/62.5 K/125 K/500 K/1 Mbps at system clock frequency of 16 MHz) LSB first/MSB first		
Watchdog timer	Reset generation interval: 3.58 ms, 14.33 ms, 57.23 ms, 458.75 ms (at oscillation of 4 MHz, minimum value)		
Flash Memory	Supports automatic programming, Embedded Algorithm and Write/Erase/Erase-Suspend/Resume commands A flag indicating completion of the algorithm Hard-wired reset vector available in order to point to a fixed boot sector in Flash Memory Boot block configuration Erase can be performed on each block Block protection with external programming voltage Flash Writer from Minato Electronics, Inc.		
Low-power consumption (stand-by) mode	Sleep/stop/CPU intermittent operation/watch timer/hardware stand-by		
Process	CMOS		
Power supply voltage for operation*2	+5 V±10 %		
Package	QFP-100		PGA-256

*1: It is setting of DIP switch S2 when Emulation pod (MB2145-507) is used.
Please refer to the MB2145-507 hardware manual (2.7 Emulator-specific Power Pin) about details.

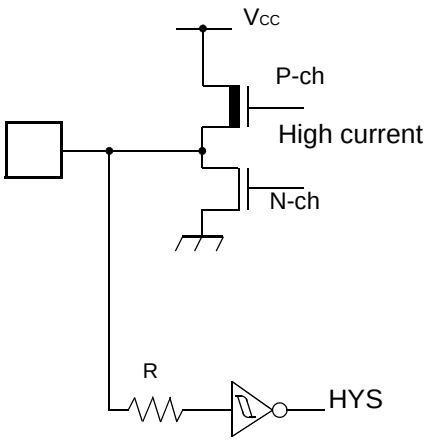
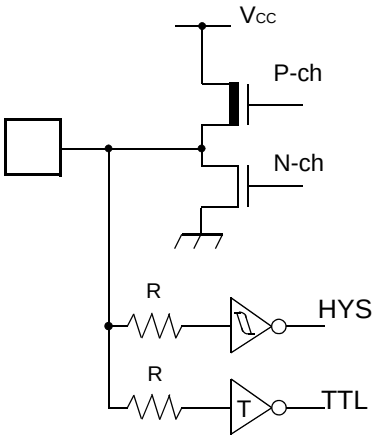
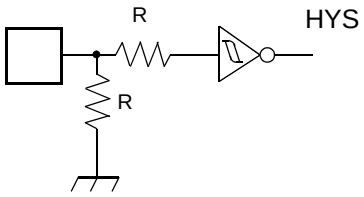
*2: Varies with conditions such as the operating frequency. (See "Electrical Characteristics.")

2. Pin Assignment



3. Pin Description

Pin no.	Pin name	Circuit type	Function
82	X0	A	Oscillator pin
83	X1		
77	$\overline{\text{RST}}$	B	Reset input
52	$\overline{\text{HST}}$	C	Hardware standby input
85 to 88	P00 to P03	G	General purpose IO
	IN0 to IN3		Inputs for the Input Captures
89 to 92	P04 to P07	G	General purpose IO
	OUT0 to OUT3		Outputs for the Output Compares.
93 to 98	P10 to P15	D	General purpose IO
	PPG0 to PPG5		Outputs for the Programmable Pulse Generators
99	P16	D	General purpose IO
	TIN1		TIN input for the 16-bit Reload Timer 1
100	P17	D	General purpose IO
	TOT1		TOT output for the 16-bit Reload Timer 1
1 to 8	P20 to P27	G	General purpose IO
9 to 10	P30 to P31	G	General purpose IO
12 to 16	P32 to P36	G	General purpose IO
17	P37	D	General purpose IO
18	P40	G	General purpose IO
	SOT0		SOT output for UART 0
19	P41	G	General purpose IO
	SCK0		SCK input/output for UART 0
20	P42	G	General purpose IO
	SIN0		SIN input for UART 0
21	P43	G	General purpose IO
	SIN1		SIN input for UART 1
22	P44	G	General purpose IO
	SCK1		SCK input/output for UART 1
24	P45	G	General purpose IO
	SOT1		SOT output for UART 1
25	P46	G	General purpose IO
	SOT2		SOT output for the Serial IO
26	P47	G	General purpose IO
	SCK2		SCK input/output for the Serial IO

Circuit Type	Circuit	Remarks
F		■ CMOS high current output ■ CMOS Hysteresis input
G		■ CMOS output ■ CMOS Hysteresis input ■ TTL input (MB90F598G, only in Flash mode)
H		■ Hysteresis input Pull-down Resistor: 50 kΩ approx. (except MB90F598G)

(5) Pull-up/down resistors
The MB90595G Series does not support internal pull-up/down resistors. Use external components where needed.

(6) Crystal Oscillator Circuit
Noises around X0 or X1 pins may cause abnormal operations. Make sure to provide bypass capacitors via shortest distance from X0, X1 pins, crystal oscillator (or ceramic resonator) and ground lines, and make sure that lines of oscillation circuit not cross the lines of other circuits.
A printed circuit board artwork surrounding the X0 and X1 pins with ground area for stabilizing the operation is highly recommended.

(7) Turning-on Sequence of Power Supply to A/D Converter and Analog Inputs
Make sure to turn on the A/D converter power supply (AV_{CC}, AVRH, AVRL) and analog inputs (AN0 to AN7) after turning-on the digital power supply (V_{CC}).
Turn-off the digital power after turning off the A/D converter supply and analog inputs. In this case, make sure that the voltage does not exceed AVRH or AV_{CC} (turning on/off the analog and digital power supplies simultaneously is acceptable).

(8) Connection of Unused Pins of A/D Converter
Connect unused pins of A/D converter to $AV_{CC} = V_{CC}$, $AV_{SS} = AVRH = DV_{CC} = V_{SS}$.

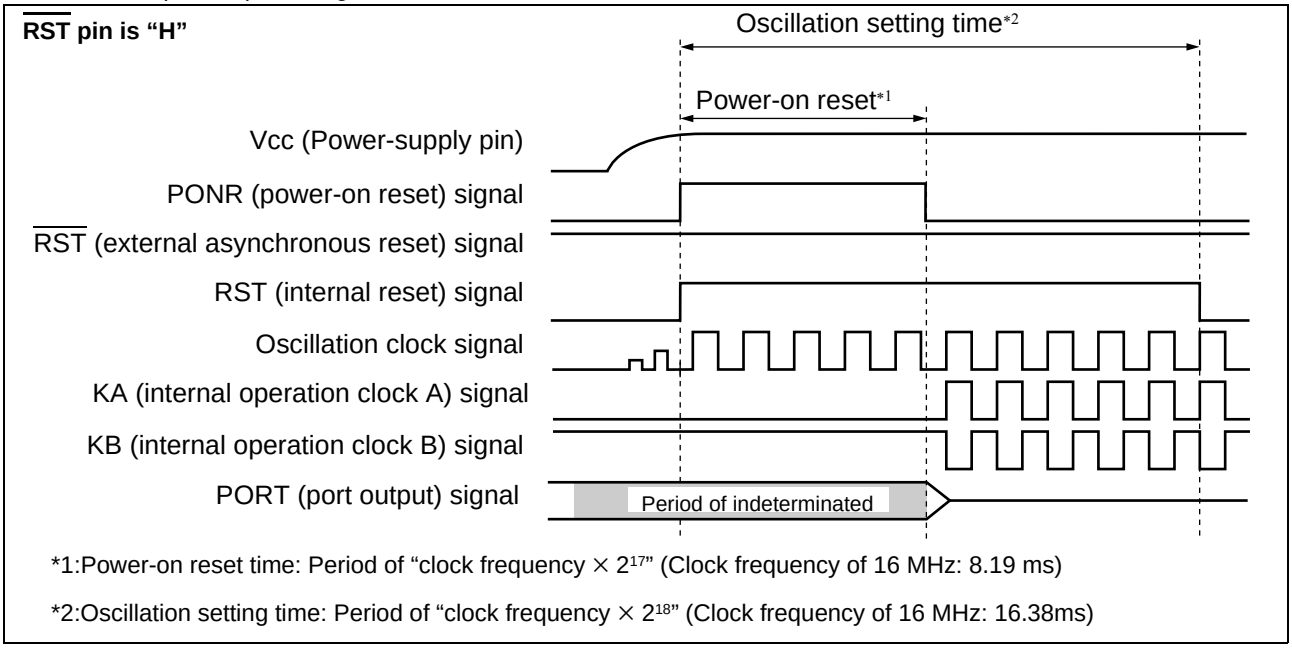
(9) N.C. Pin
The N.C. (internally connected) pin must be opened for use.

(10) Notes on Energization
To prevent the internal regulator circuit from malfunctioning, set the voltage rise time during energization at 50 µs or more (0.2 V to 2.7 V).

(11) Indeterminate outputs from ports 0 and 1 (MB90V595G only)
During oscillation setting time of step-down circuit (during a power-on reset) after the power is turned on, the outputs from ports 0 and 1 become following state.

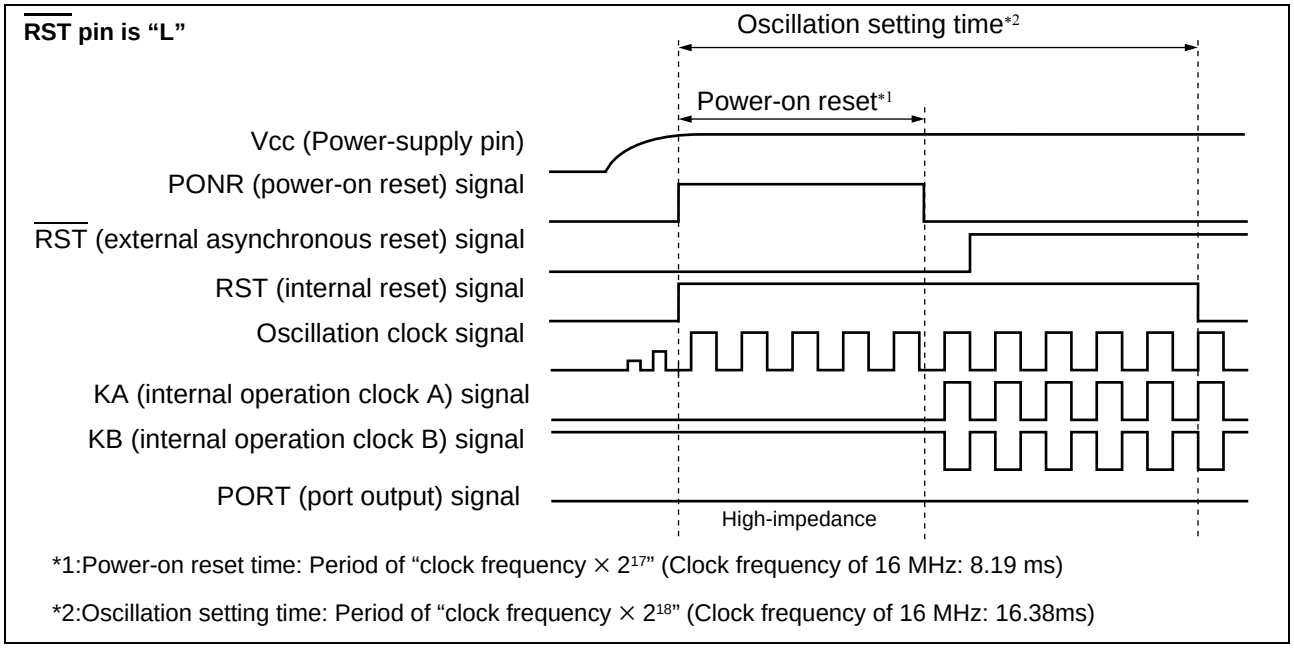
■ If $\overline{RST}$ pin is “H”, the outputs become indeterminate.

■ If $\overline{RST}$ pin is “L”, the outputs become high-impedance.
Pay attention to the port output timing shown as follows.



*1:Power-on reset time: Period of “clock frequency × 2^{17}” (Clock frequency of 16 MHz: 8.19 ms)

*2:Oscillation setting time: Period of “clock frequency × 2^{18}” (Clock frequency of 16 MHz: 16.38ms)



*1:Power-on reset time: Period of “clock frequency × 2^{17}” (Clock frequency of 16 MHz: 8.19 ms)

*2:Oscillation setting time: Period of “clock frequency × 2^{18}” (Clock frequency of 16 MHz: 16.38ms)

(12) Initialization

The device contains internal registers which are initialized only by a power-on reset. To initialize these registers, please turn on the power again.

(13) Directions of “DIV A, Ri” and “DIVW A, RWi” instructions

In the signed multiplication and division instructions (“DIV A, Ri” and “DIVW A, RWi”), the value of the corresponding bank register (DTB, ADB, USB, SSB) is set in “00_H”.

If the values of the corresponding bank register (DTB,ADB,USB,SSB) are set to other than “00_H”, the remainder by the execution result of the instruction is not stored in the register of the instruction operand.

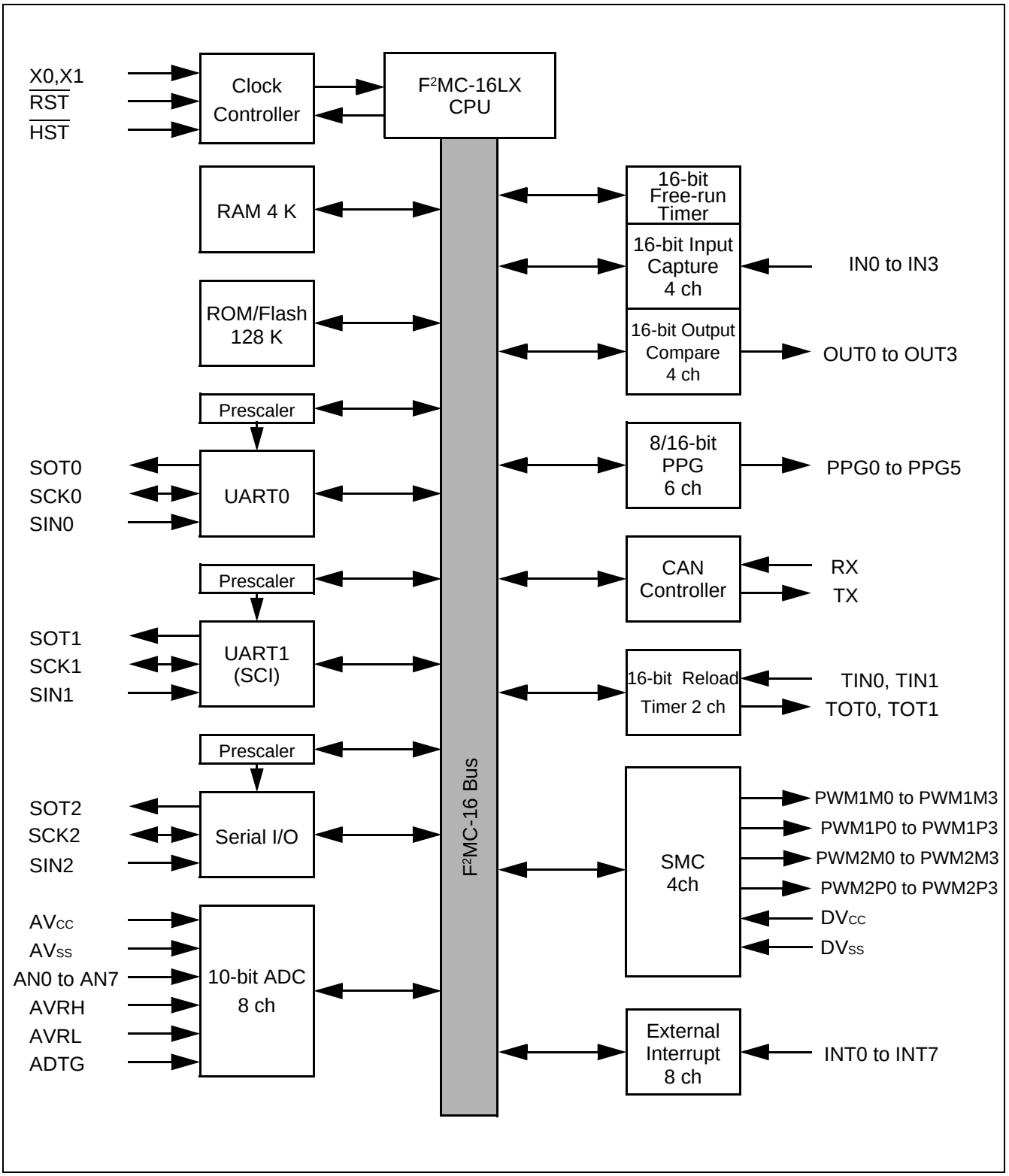
(14) Using REALOS

The use of EI^2OS is not possible with the REALOS real time operating system.

(15) Caution on Operations during PLL Clock Mode

If the PLL clock mode is selected in the microcontroller, it may attempt to continue the operation using the free-running frequency of the automatic oscillating circuit in the PLL circuitry even if the oscillator is out of place or the clock input is stopped. Performance of this operation, however, cannot be guaranteed.

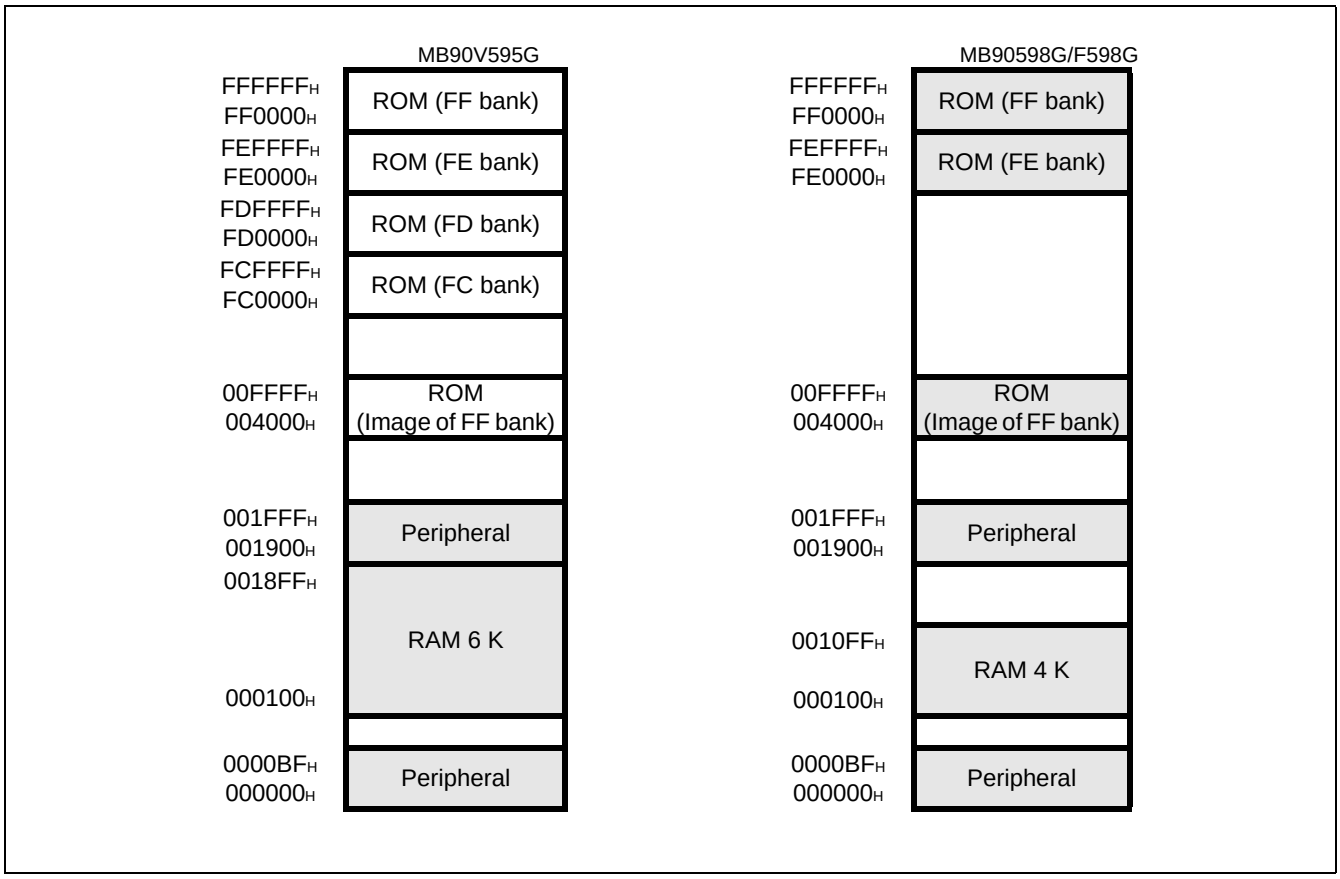
6. Block Diagram



7. Memory Space

The memory space of the MB90595G Series is shown below

Figure 1. Memory space map



Note: : The ROM data of bank FF is reflected in the upper address of bank 00, realizing effective use of the C compiler small model. The lower 16-bit of bank FF and the lower 16-bit of bank 00 are assigned to the same address, enabling reference of the table on the ROM without stating “far”.
For example, if an attempt has been made to access 00C000H , the contents of the ROM at FFC000H are accessed. Since the ROM area of the FF bank exceeds 48 Kbytes, the whole area cannot be reflected in the image for the 00 bank. The ROM data at FF4000H to FFFFFFH looks, therefore, as if it were the image for 004000H to 00FFFFH. Thus, it is recommended that the ROM data table be stored in the area of FF4000H to FFFFFFH.

Address	Register	Abbreviation	Access	Peripheral	Initial value
29H to 2AH	Reserved				
2BH	Serial IO Prescaler	SCDCR	R/W	Serial IO	0 _ _ _ 1 1 1 1B
2CH	Serial Mode Control Register (low-order)	SMCS	R/W		_ _ _ _ 0 0 0 0B
2DH	Serial Mode Control Register (high-order)	SMCS	R/W		0 0 0 0 0 0 1 0B
2EH	Serial Data Register	SDR	R/W		XXXXXXXXB
2FH	Edge Selector	SES	R/W		_ _ _ _ _ _ _ 0B
30H	External Interrupt Enable Register	ENIR	R/W	External Interrupt	0 0 0 0 0 0 0 0B
31H	External Interrupt Request Register	EIRR	R/W		XXXXXXXXB
32H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
33H	External Interrupt Level Register	ELVR	R/W		0 0 0 0 0 0 0 0B
34H	A/D Control Status Register 0	ADCS0	R/W	A/D Converter	0 0 0 0 0 0 0 0B
35H	A/D Control Status Register 1	ADCS1	R/W		0 0 0 0 0 0 0 0B
36H	A/D Data Register 0	ADCR0	R		XXXXXXXXB
37H	A/D Data Register 1	ADCR1	R/W		0 0 0 0 1 _ XXB
38H	PPG0 Operation Mode Control Register	PPGC0	R/W	16-bit Programmable Pulse Generator 0/1	0 _ 0 0 0 _ _ 1B
39H	PPG1 Operation Mode Control Register	PPGC1	R/W		0 _ 0 0 0 0 0 1B
3AH	PPG0, 1 Output Pin Control Register	PPG01	R/W		0 0 0 0 0 0 _ _B
3BH	Reserved				
3CH	PPG2 Operation Mode Control Register	PPGC2	R/W	16-bit Programmable Pulse Generator 2/3	0 _ 0 0 0 _ _ 1B
3DH	PPG3 Operation Mode Control Register	PPGC3	R/W		0 _ 0 0 0 0 0 1B
3EH	PPG2, 3 Output Pin Control Register	PPG23	R/W		0 0 0 0 0 0 _ _B
3FH	Reserved				
40H	PPG4 Operation Mode Control Register	PPGC4	R/W	16-bit Programmable Pulse Generator 4/5	0 _ 0 0 0 _ _ 1B
41H	PPG5 Operation Mode Control Register	PPGC5	R/W		0 _ 0 0 0 0 0 1B
42H	PPG4, 5 Output Pin Control Register	PPG45	R/W		0 0 0 0 0 0 _ _B
43H	Reserved				
44H	PPG6 Operation Mode Control Register	PPGC6	R/W	16-bit Programmable Pulse Generator 6/7	0 _ 0 0 0 _ _ 1B
45H	PPG7 Operation Mode Control Register	PPGC7	R/W		0 _ 0 0 0 0 0 1B
46H	PPG6, 7 Output Pin Control Register	PPG67	R/W		0 0 0 0 0 0 _ _B
47H	Reserved				
48H	PPG8 Operation Mode Control Register	PPGC8	R/W	16-bit Programmable Pulse Generator 8/9	0 _ 0 0 0 _ _ 1B
49H	PPG9 Operation Mode Control Register	PPGC9	R/W		0 _ 0 0 0 0 0 1B
4AH	PPG8, 9 Output Pin Control Register	PPG89	R/W		0 0 0 0 0 0 _ _B
4BH	Reserved				

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
4C$_H$	PPGA Operation Mode Control Register	PPGCA	R/W	16-bit Programmable Pulse Generator A/B	0 _ 0 0 0 _ _ 1$_B$
4D$_H$	PPGB Operation Mode Control Register	PPGCB	R/W		0 _ 0 0 0 0 0 1$_B$
4E$_H$	PPGA, B Output Pin Control Register	PPGAB	R/W		0 0 0 0 0 0 _ _$_B$
4F$_H$	Reserved				
50$_H$	Timer Control Status Register 0	TMCSR0	R/W	16-bit Reload Timer 0	0 0 0 0 0 0 0 0$_B$
51$_H$	Timer Control Status Register 0	TMCSR0	R/W		_ _ _ _ 0 0 0 0$_B$
52$_H$	Timer 0/Reload Register 0	TMR0/TMRLR0	R/W		XXXXXXXX$_B$
53$_H$	Timer 0/Reload Register 0	TMR0/TMRLR0	R/W		XXXXXXXX$_B$
54$_H$	Timer Control Status Register 1	TMCSR1	R/W	16-bit Reload Timer 1	0 0 0 0 0 0 0 0$_B$
55$_H$	Timer Control Status Register 1	TMCSR1	R/W		_ _ _ _ 0 0 0 0$_B$
56$_H$	Timer Register 1/Reload Register 1	TMR1/TMRLR1	R/W		XXXXXXXX$_B$
57$_H$	Timer Register 1/Reload Register 1	TMR1/TMRLR1	R/W		XXXXXXXX$_B$
58$_H$	Output Compare Control Status Register 0	OCS0	R/W	Output Compare 0/1	0 0 0 0 _ _ 0 0$_B$
59$_H$	Output Compare Control Status Register 1	OCS1	R/W		_ _ _ 0 0 0 0 0$_B$
5A$_H$	Output Compare Control Status Register 2	OCS2	R/W	Output Compare 2/3	0 0 0 0 _ _ 0 0$_B$
5B$_H$	Output Compare Control Status Register 3	OCS3	R/W		_ _ _ 0 0 0 0 0$_B$
5C$_H$	Input Capture Control Status Register 0/1	ICS01	R/W	Input Capture 0/1	0 0 0 0 0 0 0 0$_B$
5D$_H$	Input Capture Control Status Register 2/3	ICS23	R/W	Input Capture 2/3	0 0 0 0 0 0 0 0$_B$
5E$_H$	PWM Control Register 0	PWC0	R/W	Stepping Motor Controller 0	0 0 0 0 0 _ _ 0$_B$
5F$_H$	Reserved				
60$_H$	PWM Control Register 1	PWC1	R/W	Stepping Motor Controller 1	0 0 0 0 0 _ _ 0$_B$
61$_H$	Reserved				
62$_H$	PWM Control Register 2	PWC2	R/W	Stepping Motor Controller 2	0 0 0 0 0 _ _ 0$_B$
63$_H$	Reserved				
64$_H$	PWM Control Register 3	PWC3	R/W	Stepping Motor Controller 3	0 0 0 0 0 _ _ 0$_B$
65$_H$	Reserved				
66$_H$	Timer Data Register (low-order)	TCDT	R/W	16-bit Free-run Timer	0 0 0 0 0 0 0 0$_B$
67$_H$	Timer Data Register (high-order)	TCDT	R/W		0 0 0 0 0 0 0 0$_B$
68$_H$	Timer Control Status Register	TCCS	R/W		0 0 0 0 0 0 0 0$_B$
69$_H$ to 6E$_H$	Reserved				

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
6F$_H$	ROM Mirror Function Selection Register	ROMM	R/W	ROM Mirror	_ _ _ _ _ _ _ 1$_B$
70$_H$	PWM1 Compare Register 0	PWC10	R/W	Stepping Motor Controller 0	XXXXXXXX$_B$
71$_H$	PWM2 Compare Register 0	PWC20	R/W		XXXXXXXX$_B$
72$_H$	PWM1 Select Register 0	PWS10	R/W		_ _ 0 0 0 0 0 0$_B$
73$_H$	PWM2 Select Register 0	PWS20	R/W		_ 0 0 0 0 0 0 0$_B$
74$_H$	PWM1 Compare Register 1	PWC11	R/W	Stepping Motor Controller 1	XXXXXXXX$_B$
75$_H$	PWM2 Compare Register 1	PWC21	R/W		XXXXXXXX$_B$
76$_H$	PWM1 Select Register 1	PWS11	R/W		_ _ 0 0 0 0 0 0$_B$
77$_H$	PWM2 Select Register 1	PWS21	R/W		_ 0 0 0 0 0 0 0$_B$
78$_H$	PWM1 Compare Register 2	PWC12	R/W	Stepping Motor Controller 2	XXXXXXXX$_B$
79$_H$	PWM2 Compare Register 2	PWC22	R/W		XXXXXXXX$_B$
7A$_H$	PWM1 Select Register 2	PWS12	R/W		_ _ 0 0 0 0 0 0$_B$
7B$_H$	PWM2 Select Register 2	PWS22	R/W		_ 0 0 0 0 0 0 0$_B$
7C$_H$	PWM1 Compare Register 3	PWC13	R/W	Stepping Motor Controller 3	XXXXXXXX$_B$
7D$_H$	PWM2 Compare Register 3	PWC23	R/W		XXXXXXXX$_B$
7E$_H$	PWM1 Select Register 3	PWS13	R/W		_ _ 0 0 0 0 0 0$_B$
7F$_H$	PWM2 Select Register 3	PWS23	R/W		_ 0 0 0 0 0 0 0$_B$
80$_H$ to 8F$_H$	CAN Controller. Refer to section about CAN Controller				
90$_H$ to 9D$_H$	Reserved				
9E$_H$	Program Address Detection Control Status Register	PACSR	R/W	Address Match Detection Function	0 0 0 0 0 0 0 0$_B$
9F$_H$	Delayed Interrupt/Request Register	DIRR	R/W	Delayed Interrupt	_ _ _ _ _ _ _ 0$_B$
A0$_H$	Low-Power Mode Control Register	LPMCR	R/W	Low Power Controller	0 0 0 1 1 0 0 0$_B$
A1$_H$	Clock Selection Register	CKSCR	R/W	Low Power Controller	1 1 1 1 1 1 0 0$_B$
A2$_H$ to A7$_H$	Reserved				
A8$_H$	Watchdog Timer Control Register	WDTC	R/W	Watchdog Timer	XXXXX 1 1 1$_B$
A9$_H$	Time Base Timer Control Register	TBTC	R/W	Time Base Timer	1 _ _ 0 0 1 0 0$_B$
AA$_H$ to AD$_H$	Reserved				
AE$_H$	Flash Memory Control Status Register (MB90F598G only. Otherwise reserved)	FMCS	R/W	Flash Memory	0 0 0 X 0 0 0 0$_B$
AF$_H$	Reserved				

(Continued)

(Continued)

Address	Register	Abbreviation	Access	Peripheral	Initial value
192C$_H$	Output Compare Register 2 (low-order)	OCCP2	R/W	Output Compare 2/3	XXXXXXXX$_B$
192D$_H$	Output Compare Register 2 (high-order)	OCCP2	R/W		XXXXXXXX$_B$
192E$_H$	Output Compare Register 3 (low-order)	OCCP3	R/W		XXXXXXXX$_B$
192F$_H$	Output Compare Register 3 (high-order)	OCCP3	R/W		XXXXXXXX$_B$
1930$_H$ to 19FF$_H$	Reserved				
1A00$_H$ to 1AFF$_H$	CAN Controller. Refer to section about CAN Controller				
1B00$_H$ to 1BFF$_H$	CAN Controller. Refer to section about CAN Controller				
1C00$_H$ to 1EFF$_H$	Reserved				
1FF0$_H$	Program Address Detection Register 0 (low-order)	PADR0	R/W	Address Match Detection Function	XXXXXXXX$_B$
1FF1$_H$	Program Address Detection Register 0 (middle-order)				XXXXXXXX$_B$
1FF2$_H$	Program Address Detection Register 0 (high-order)				XXXXXXXX$_B$
1FF3$_H$	Program Address Detection Register 1 (low-order)	PADR1	R/W		XXXXXXXX$_B$
1FF4$_H$	Program Address Detection Register 1 (middle-order)				XXXXXXXX$_B$
1FF5$_H$	Program Address Detection Register 1 (high-order)				XXXXXXXX$_B$
1FF6$_H$ to 1FFF$_H$	Reserved				

■ Description for Read/Write
R/W : Readable/writable
R : Read only
W : Write only

■ Description of initial value
0 : the initial value of this bit is "0".
1 : the initial value of this bit is "1".
X : the initial value of this bit is undefined.
_ : this bit is unused. the initial value is undefined.

Note: : Addresses in the range of 0000$_H$ to 00FF$_H$, which are not listed in the table, are reserved for the primary functions of the MCU. A read access to these reserved addresses results in reading “X”, and any write access should not be performed.

9. Can Controller

The CAN controller has the following features:

- Conforms to CAN Specification Version 2.0 Part A and B
  - - Supports transmission/reception in standard frame and extended frame formats
- Supports transmission of data frames by receiving remote frames
- 16 transmitting/receiving message buffers
  - 29-bit ID and 8-byte data
  - Multi-level message buffer configuration
- Provides full-bit comparison, full-bit mask, acceptance register 0/acceptance register 1 for each message buffer as ID acceptance mask
  - Two acceptance mask registers in either standard frame format or extended frame format
- Bit rate programmable from 10 kbps to 2 Mbps (when input clock is at 16 MHz)

9.1 List of Control Registers

Address	Register	Abbreviation	Access	Initial Value
000080H	Message buffer valid register	BVALR	R/W	00000000 00000000B
000081H				
000082H	Transmit request register	TREQR	R/W	00000000 00000000B
000083H				
000084H	Transmit cancel register	TCANR	W	00000000 00000000B
000085H				
000086H	Transmit complete register	TCR	R/W	00000000 00000000B
000087H				
000088H	Receive complete register	RCR	R/W	00000000 00000000B
000089H				
00008AH	Remote request receiving register	RRTRR	R/W	00000000 00000000B
00008BH				
00008CH	Receive overrun register	ROVRR	R/W	00000000 00000000B
00008DH				
00008EH	Receive interrupt enable register	RIER	R/W	00000000 00000000B
00008FH				
001B00H	Control status register	CSR	R/W, R	00---000 0----0-1B
001B01H				
001B02H	Last event indicator register	LEIR	R/W	-------- 000-0000B
001B03H				
001B04H	Receive/transmit error counter	RTEC	R	00000000 00000000B
001B05H				
001B06H	Bit timing register	BTR	R/W	-1111111 11111111B
001B07H				

(Continued)

11.2 Recommended Conditions

(V_{SS} = AV_{SS} = 0.0 V)

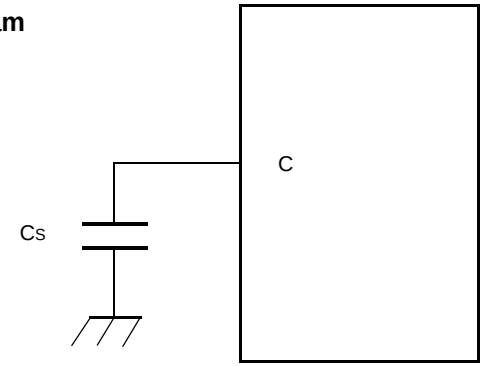
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Power supply voltage	V_{CC} AV_{CC}	4.5	5.0	5.5	V	Under normal operation
		3.0	—	5.5	V	Maintains RAM data in stop mode
Smooth capacitor	C_S	0.022	0.1	1.0	µF	*
Operating temperature	T_A	–40	—	+85	°C	

*: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The smoothing capacitor to be connected to the V_{CC} pin must have a capacitance value higher than C_S.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

- **C Pin Connection Diagram**



11.3 DC Characteristics

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = –40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input H voltage	V_{IHS}	CMOS hysteresis input pin	—	0.8 V_{CC}	—	V_{CC} +0.3	V	
	V_{IHM}	MD input pin	—	V_{CC} – 0.3	—	V_{CC} +0.3	V	
Input L voltage	V_{ILS}	CMOS hysteresis input pin	—	V_{SS} – 0.3	—	0.2 V_{CC}	V	
	V_{ILM}	MD input pin	—	V_{SS} – 0.3	—	V_{SS} +0.3	V	
Output H voltage	V_{OH1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OH1} = –4.0 mA	V_{CC} – 0.5	—	—	V	
	V_{OH2}	P70 to P87	V_{CC} = 4.5 V, I_{OH2} = –30.0 mA	V_{CC} – 0.5	—	—	V	
Output L voltage	V_{OL1}	Output pins except P70 to P87	V_{CC} = 4.5 V, I_{OL1} = 4.0 mA	—	—	0.4	V	
	V_{OL2}	P70 to P87	V_{CC} = 4.5 V, I_{OL2} = 30.0 mA	—	—	0.5	V	

(Continued)

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Input capacity	C_{IN}	Other than C, AV_{CC}, AV_{SS}, AVRH, AVRL, V_{CC}, V_{SS}, DV_{CC}, DV_{SS}, P70 to P87	—	—	5	15	pF	
		P70 to P87	—	—	15	30	pF	
Pull-up resistance	R_{UP}	$\overline{RST}$	—	25	50	100	kΩ	
Pull-down resistance	R_{DOWN}	MD2	—	25	50	100	kΩ	

* : The power supply current testing conditions are when using the external clock.

11.4 AC Characteristics

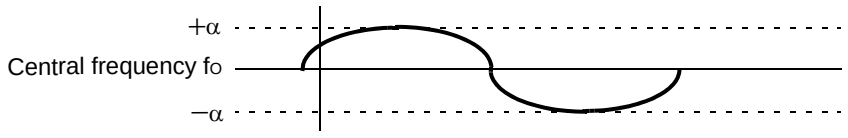
11.4.1 Clock Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

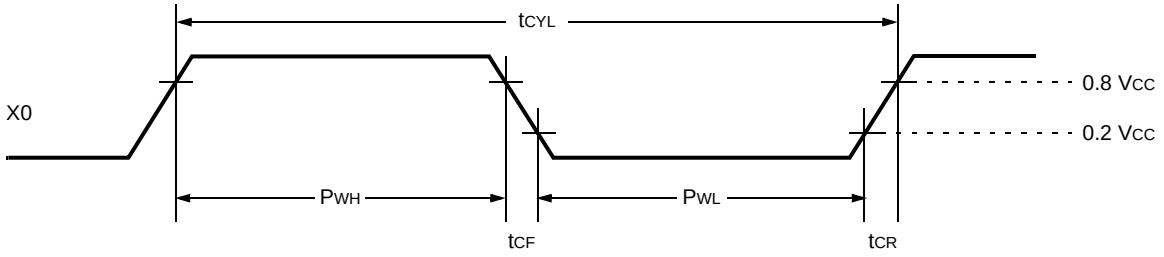
Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Oscillation frequency	f_C	X0, X1	3	—	5	MHz	When using oscillation circuit
Oscillation cycle time	t_{CYL}	X0, X1	200	—	333	ns	When using oscillation circuit
External clock frequency	f_C	X0, X1	3	—	16	MHz	When using external clock
External clock cycle time	t_{CYL}	X0, X1	62.5	—	333	ns	When using external clock
Frequency deviation with PLL *	Δf	—	—	—	5	%	
Input clock pulse width	P_{WH}, P_{WL}	X0	10	—	—	ns	Duty ratio is about 30 to 70%.
Input clock rise and fall time	t_{CR}, t_{CF}	X0	—	—	5	ns	When using external clock
Machine clock frequency	f_{CP}	—	1.5	—	16	MHz	
Machine clock cycle time	t_{CP}	—	62.5	—	666	ns	
Flash Read cycle time	t_{CYL}	—	—	2*t_{CP}	—	ns	When Flash is accessed via CPU

*: Frequency deviation indicates the maximum frequency difference from the target frequency when using a multiplied clock.

$$\Delta f = \frac{|\alpha|}{fo} \times 100\%$$



- **Clock Timing**

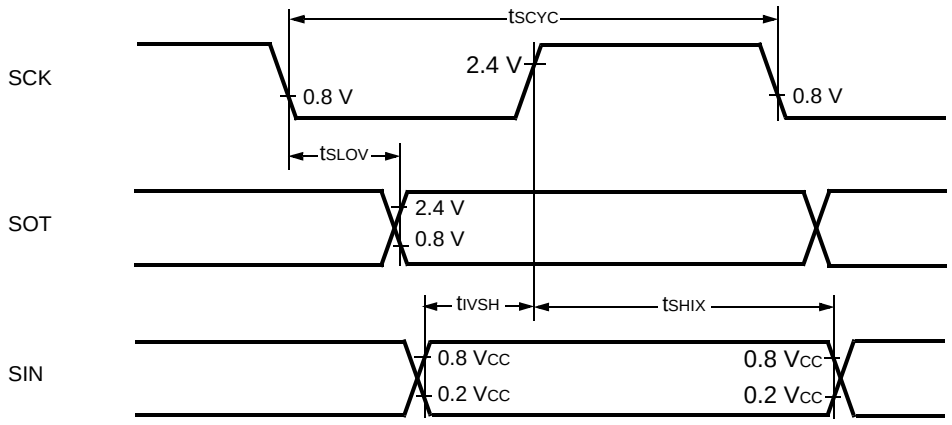


Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Serial clock “H” pulse width	t_{SHSL}	SCK0 to SCK2	External clock operation output pins are C_L = 80 pF + 1 TTL.	4 t_{CP}	—	ns	
Serial clock “L” pulse width	t_{SLSH}	SCK0 to SCK2		4 t_{CP}	—	ns	
SCK ↓ ⇒ SOT delay time	t_{SLOV}	SCK0 to SCK2, SOT0 to SOT2		—	150	ns	
Valid SIN ⇒ SCK ↑	t_{IVSH}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	
SCK ↑ ⇒ Valid SIN hold time	t_{SHIX}	SCK0 to SCK2, SIN0 to SIN2		60	—	ns	

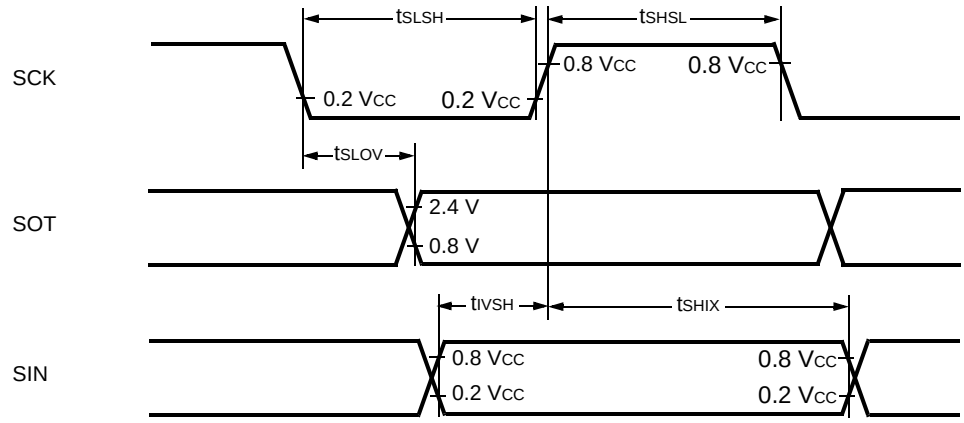
Notes:

- AC characteristic in CLK synchronized mode.
- C_L is load capacity value of pins when testing.
- t_{cp} (external operation clock cycle time) : see Clock timing.

- **Internal Shift Clock Mode**



• **External Shift Clock Mode**

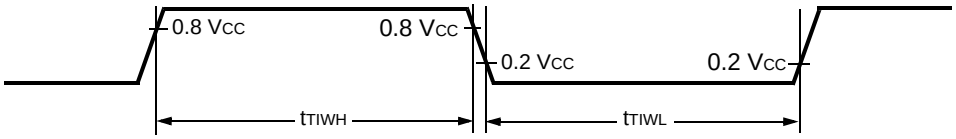


(5) Timer Input Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}	TIN0, TIN1	—	4 t_{CP}	—	ns	
	t_{TIWL}	IN0 to IN3					

• **Timer Input Timing**



11.4.5 Trigger Input Timing

(V_{CC} = 5.0 V±10%, V_{SS} = AV_{SS} = 0.0 V, T_A = −40 °C to +85 °C)

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH} t_{TRGL}	INT0 to INT7, ADTG	—	5 t_{CP}	—	ns	Under normal operation
				1	—	µs	In stop mode

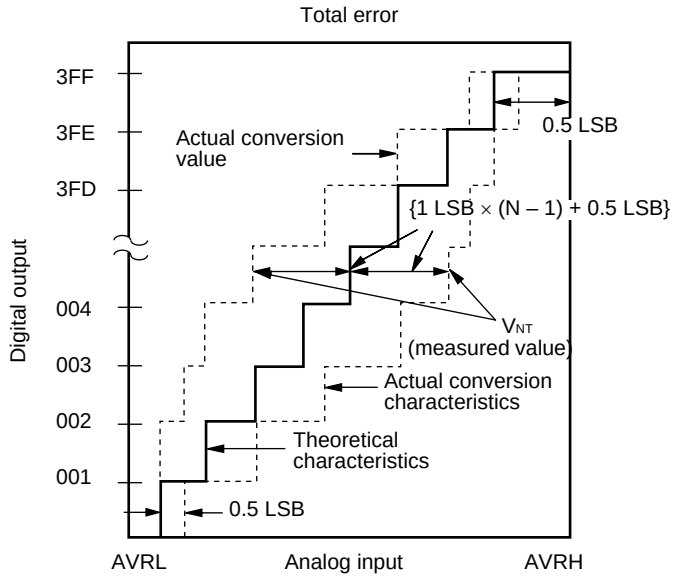
11.6 A/D Converter Glossary

Resolution: Analog changes that are identifiable with the A/D converter

Linearity error: The deviation of the straight line connecting the zero transition point (“00 0000 0000” ↔ “00 0000 0001”) with the full-scale transition point (“11 1111 1110” ↔ “11 1111 1111”) from actual conversion characteristics

Differential linearity error: The deviation of input voltage needed to change the output code by 1 LSB from the theoretical value

Total error: The total error is defined as a difference between the actual value and the theoretical value, which includes zero-transition error/full-scale transition error and linearity error.



1 LSB = (Theoretical value) $\frac{AVRH - AVRL}{1024}$ [V]

Total error for digital output N = $\frac{V_{NT} - \{1\ LSB \times (N - 1) + 0.5\ LSB\}}{1\ LSB}$ [LSB]

V_{OT} (Theoretical value) = AVRL + 0.5 LSB[V]

V_{NT}: Voltage at a transition of digital output from (N – 1) to N

V_{FST} (Theoretical value) = AVRH – 1.5 LSB[V]

(Continued)

Supply Current